

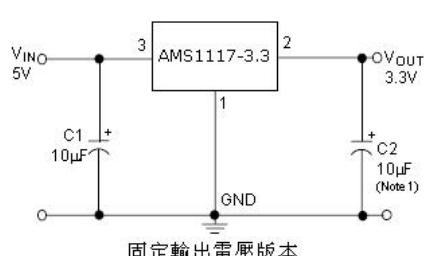
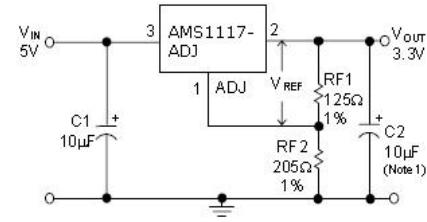
■ overview

AMS1117 is an output current up to 1A three-terminal output low dropout linear regulator, with 1.2V, 1.8V, 2.5V, 3.3V, 5.0V and adjustable output voltage versions with a voltage drop in the 1A only for 1.2V. With its excellent performance and extreme economic performance, it is suitable for various electrical products Taste.

■ features

- 1A The voltage drop at the output current is only 1.2V
- Current limiting function
- Overheat protection function
- with fixed output voltage 1.2V, 1.8V, 2.5V, 3.3V, 5.0V and adjustable output voltage versions
- fixed output voltage 1.2V The voltage accuracy is 2%
- fixed output voltage 1.8V, 2.5V, 3.3V, 5.0V and adjustable output voltage with an accuracy of 1.5%
- temperature range: -40°C ~ +125°C

■ Typical Application Circuit

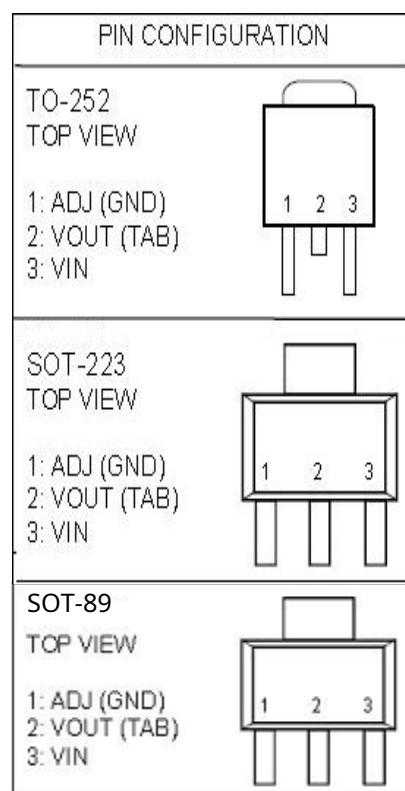


$$V_{ref} = V_{out} - V_{adj} = 1.25V \text{ (typical value)}$$

$$V_{out} = V_{ref} * (1 + RF_2 / RF_1) + I_{adj} * RF_2$$

$$I_{adj} = 55\mu A \text{ (typical value)}$$

■ Package and pin definition

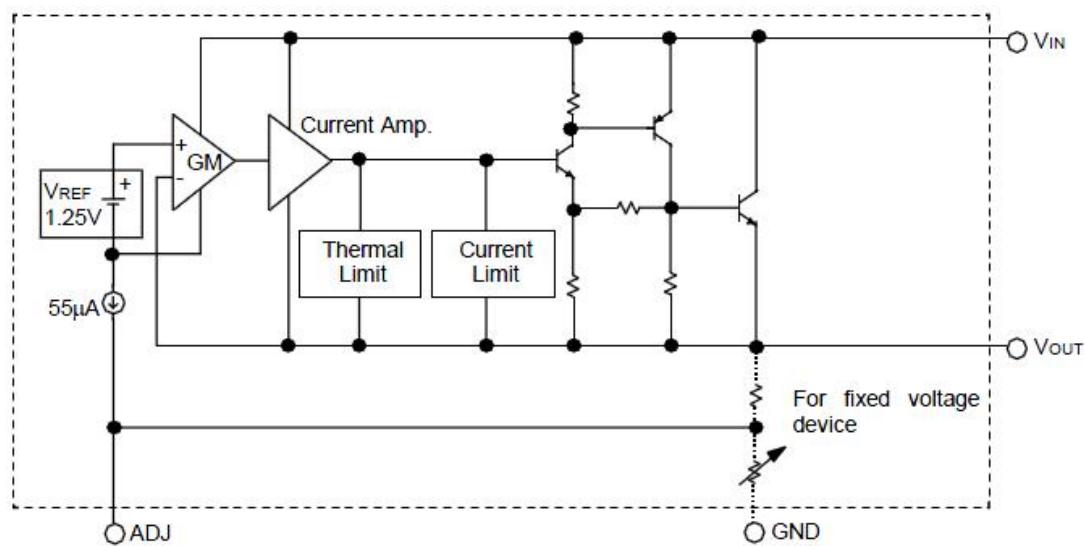


(commonly packaged as SOT-223, TO-252)

■ application

- Laptops, PDAs & Notebooks
- battery charger
- SCSI-II active terminal
- mobile phone
- cordless phone
- battery powered system
- portable device
- Switching power supply post regulator

Internal block diagram



Limit parameter

parameter	symbol	scope	unit
Input working voltage	Vin	18	V
Pin temperature (soldering5Second)	Tlead	260	°C
Operating Junction Temperature Range	Tj	150	°C
Storage temperature	Tstg	-65~+150	°C
power consumption	PD	Internal Limits (Note1)	mW
ESD Capability (minimum)	ESD	2000	V

Note1: The maximum allowable power dissipation is the maximum operating junction temperature $T_j(\max)$, junction-to-air thermal resistance as a function of ambient temperature. The maximum allowable power dissipation is at a given ambient temperature. Exceeding the maximum allowable power dissipation will cause the chip temperature to be too high, and the regulator will enter the overheating protection state. The junction-to-air thermal resistance of different package types is different, which is determined by the packaging technology.

Recommended working conditions

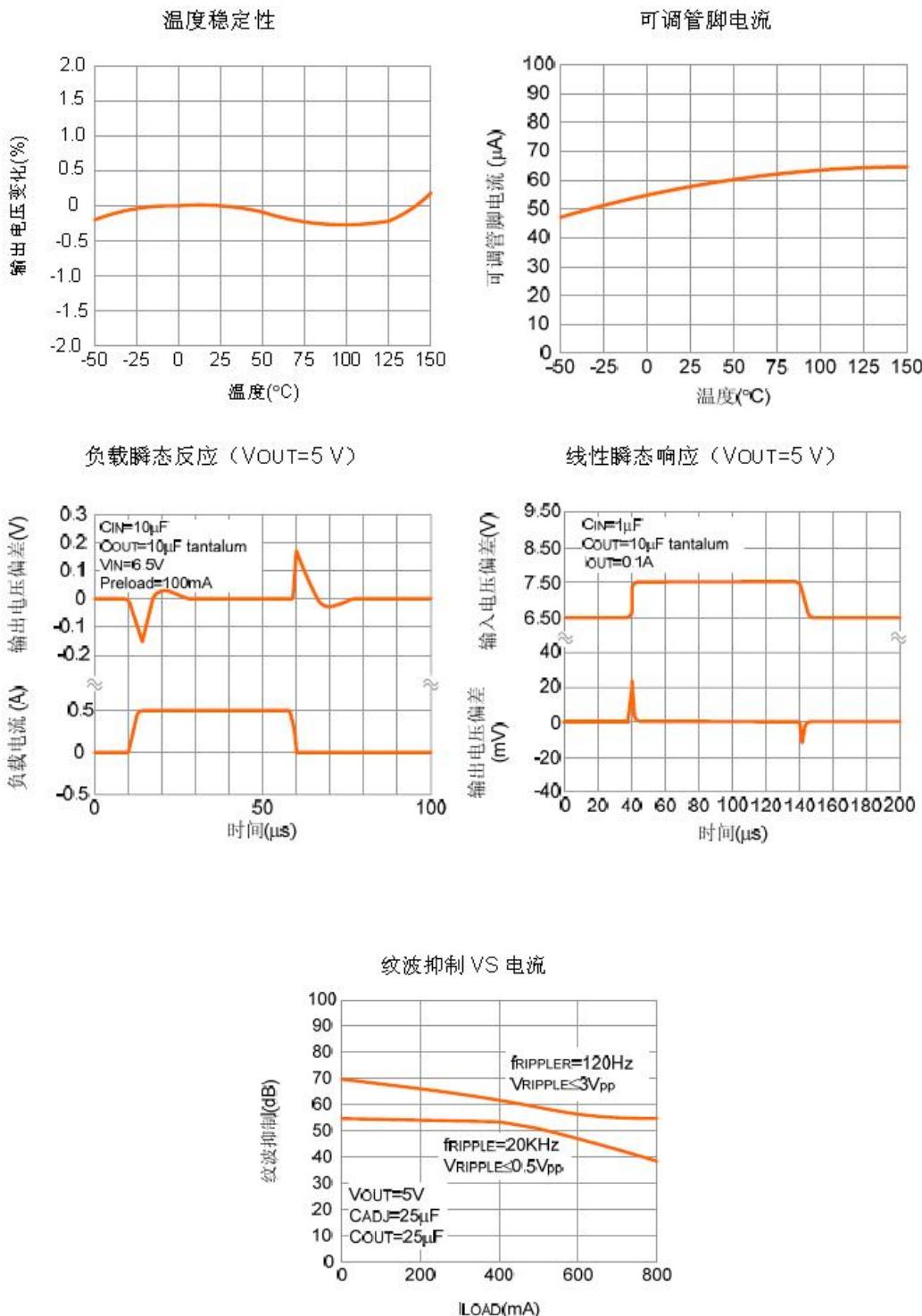
parameter	symbol	scope	unit
Input voltage	Vin	12	V
Operating Junction Temperature Range	Tj	- 40~+125	°C

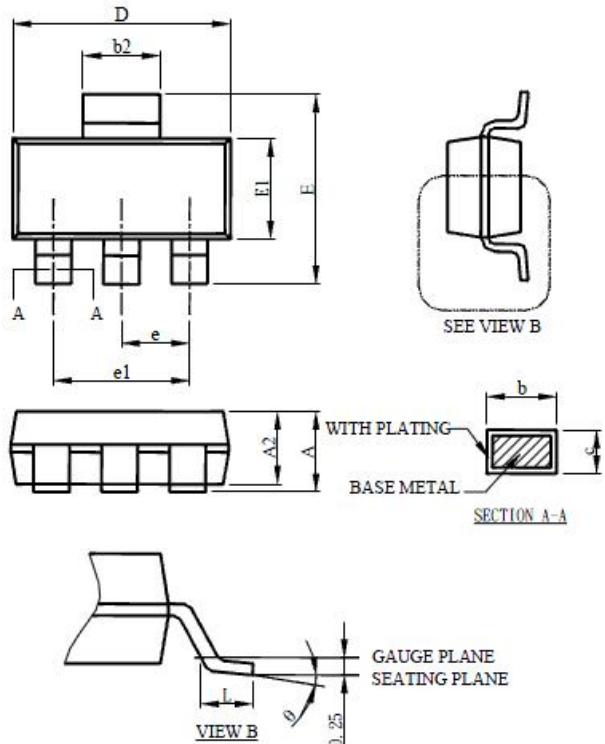
█ electrical characteristics (Unless otherwise specified, the parameters shown in black font, Tamb=25°C, normal operating junction temperature range -40~+125°C)

parameter	symbol	Test Conditions	minimum value	typical value	maximum value	unit
The reference voltage	Vref	AMS1117-ADJ, IOUT=10mA, VIN-VOUT=2V, TJ=25°C 10mA≤IOUT≤1A, 1.4V≤VIN-VOUT≤10V	1.231 1.225	1.250 1.250	1.268 1.275	V
The output voltage	Vout	AMS1117-1.2, IOUT=10mA, VIN=3.2V , TJ=25°C 10mA≤ IOUT≤1A, 3.0V≤VIN≤10V	1.176 1.152	1.200 1.200	1.224 1.248	V
		AMS1117-1.5, IOUT=10mA, VIN=3.5V, TJ=25°C 10mA≤ IOUT≤1A, 3.0V≤VIN≤10V	1.477 1.470	1.500 1.500	1.522 1.530	V
		AMS1117-1.8, IOUT=10mA, VIN=3.8V, TJ=25°C , 0≤IOUT≤1A, 3.2V≤VIN≤10V	1.773 1.746	1.800 1.800	1.827 1.854	V
		AMS1117-2.5, IOUT=10mA, VIN=4.5V,TJ=25°C , 0≤IOUT≤1A, 3.9V≤VIN≤10V	2.462 2.450	2.500 2.500	2.538 2.550	V
		AMS1117-3.3, IOUT=10mA, VIN=5V, TJ=25°C , 0≤IOUT≤1A, 4.75V≤VIN≤10V	3.250 3.235	3.300 3.300	3.349 3.365	V
		AMS1117-5.0, IOUT=10mA, VIN=7V, TJ=25°C , 0 ≤IOUT≤1A, 6.5V≤VIN≤12V	4.925 4.900	5.000 5.000	5.075 5.100	V
output voltage temperature stability	TSout			0.3		%
linear adjustment	Rline	VINMIN≤VIN≤12V, VOUT=Fixed/Adj, Iout=10mA		6	15	mV
load regulation	Rload	10mA≤IOUT≤1A, VOUT=Fixed/Adj		6	18	mV
differential pressure	Vdrop	IOUT=100mA IOUT=500mA IOUT=1A		1.00 1.05 1.20	1.20 1.25 1.30	V
Quiescent Current	Iq	4.25V≤VIN≤6.5V		5	10	mA
Ripple rejection ratio	PSRR	fRIPPLE=120Hz, (VIN-VOUT)=3V, VRIPPLE=1VPP	50	60		dB
Adjustable pin current	Iadj			60	120	uA
Adjustable pin current Variety		0≤IOUT≤800mA, 1.4V ≤VIN-VOUT≤10V		0.2	5	uA

參數	符號	測試條件	最小值	典型值	最大值	單位
溫度保護點	TSD			150		°C
限流保護點	Ilimit		1.4	1.6	1.8	A
溫度穩定性				0.5		%
長期穩定性		TA=125°C, 1000Hrs		0.3		%
RMS 輸出噪聲		% of VOUT, 10Hz≤f≤10kHz		0.005		%
熱阻係數 (無散熱片)	θ_{JA}	SOT223-3L		120		°C/W
		TO252-2L		100		
熱阻係數 (結到殼)	θ_{JC}	SOT89-3L		30		°C/W
		SOT223-3L		15		
		TO252-2L		10		
		TO-220		4.5		

█ Typical electrical characteristic curve



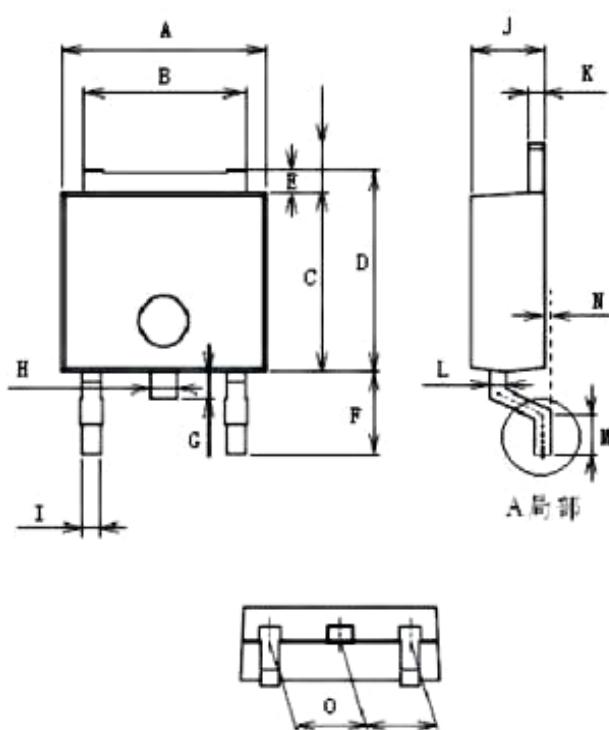
 SOT223 Package Outline Drawing

S Y M B O L	SOT-223	
	MILLIMETERS	
	MIN.	MAX.
A		1.80
A1	0.02	0.10
A2	1.55	1.65
b	0.66	0.84
b2	2.90	3.10
c	0.23	0.33
D	6.30	6.70
E	6.70	7.30
E1	3.30	3.70
e	2.30 BSC	
e1	4.60 BSC	
L	0.90	
θ	0°	8°

Note:

1. Refer to JEDEC TO-261AA.
2. Dimension D and E1 are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs, and interlead flash, but including any mismatch between the top and bottom of the plastic body.
3. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

■ TO-252 Package Outline Drawing



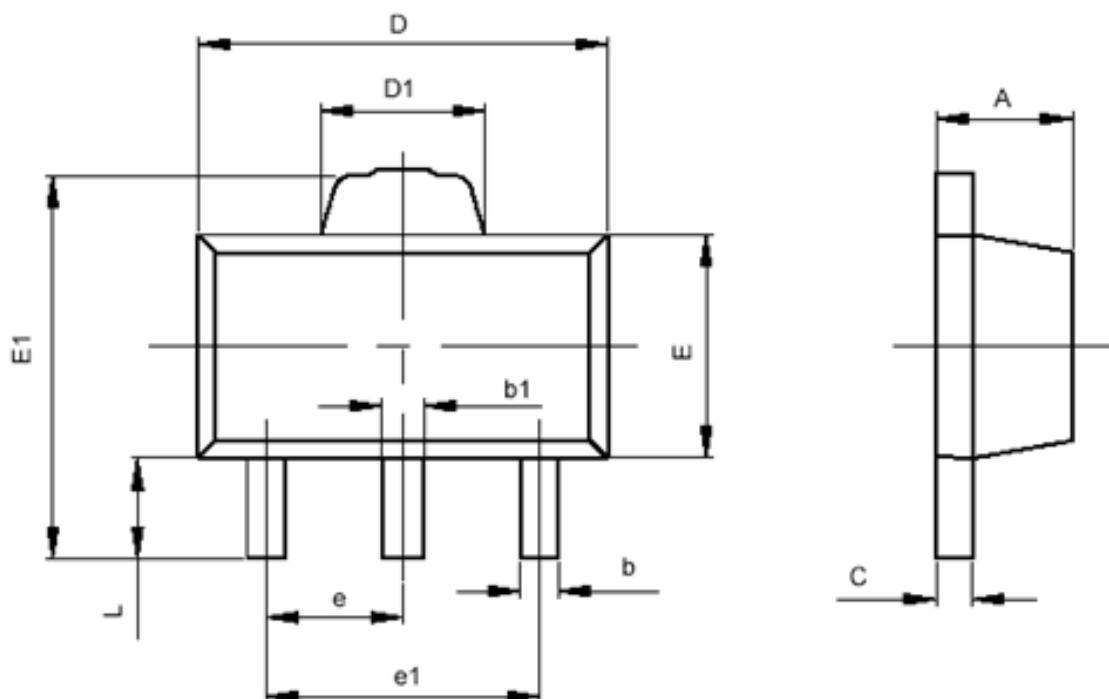
Unit: mm

Item	Min	Max
A	6.40	6.70
B	5.20	5.40
C	6.00	6.30
D	6.55	6.85
E	0.45	0.60
F	3.07	3.35
G	0.85	1.05
H	0.75	0.95
I	0.55	0.75
J	2.20	2.40
K	0.43	0.58
L	0.43	0.58
M	0.90	1.10
N	0.90	1.10
O	2.20	2.40

statement:

- Our company reserves the right to change the manual without prior notice;
- Any semiconductor product has the possibility of failure or failure under the characteristic conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design and complete machine manufacturing, so as to avoid potential failure risks that may cause personal injury or the occurrence of property damage;
- There is no end to product improvement, and our company will wholeheartedly provide customers with better semiconductor products.

SOT-89 Package Outline Drawing



符号	最小值 (mm)	最大值 (mm)
A	1.400	1.600
b	0.320	0.520
b1	0.360	0.560
c	0.350	0.440
D	4.400	4.600
D1	1.400	1.800
E	2.300	2.600
E1	3.940	4.250
e	1.500TYP	
e1	2.900	3.100
L	0.900	1.100